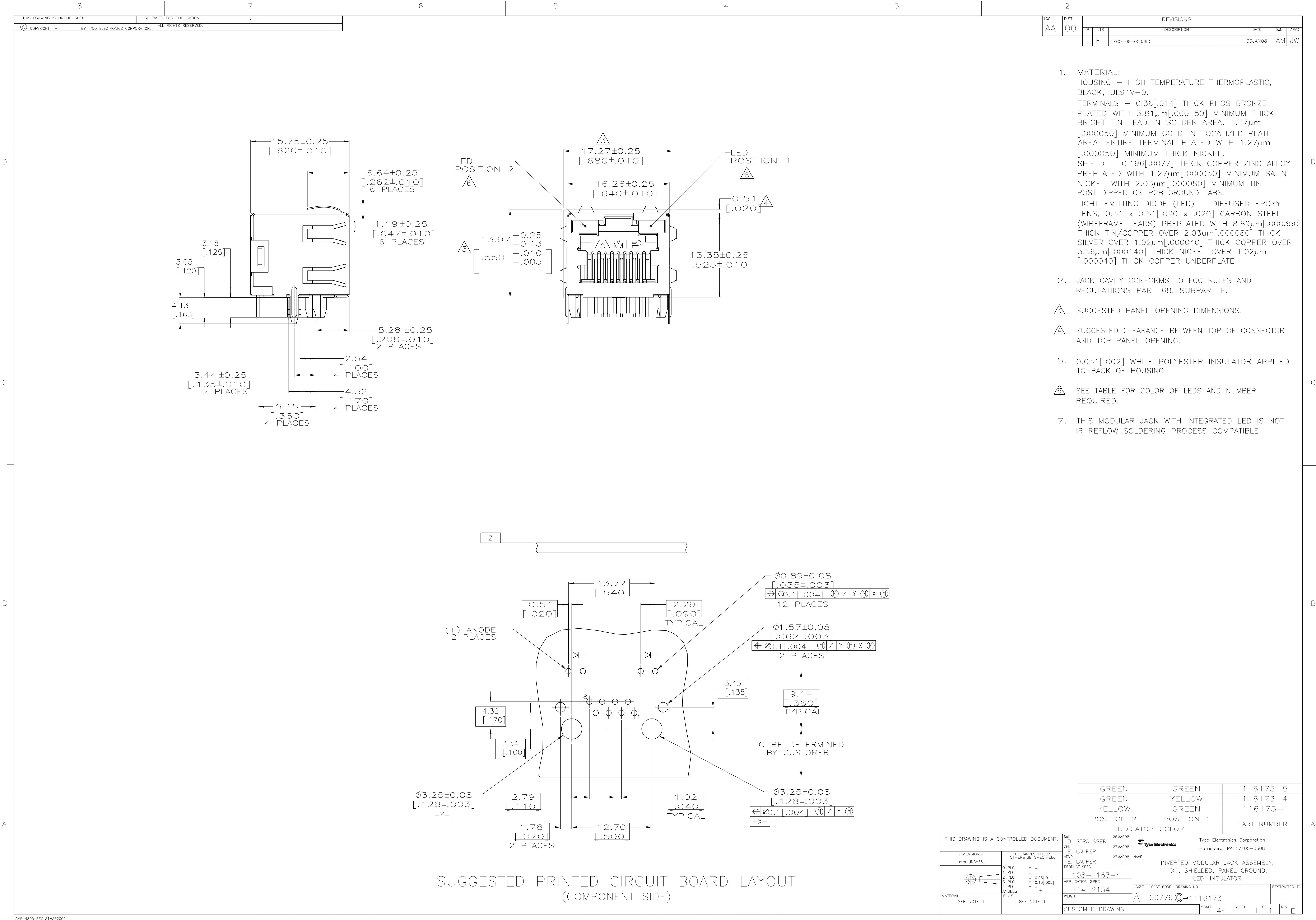




LOC	DIST	REVISIONS					
AA	00	P	LTR	DESCRIPTION	DATE	DWN	APVD
			E	ECO-08-000390	09JAN08	LAM	JW

- MATERIAL:
HOUSING – HIGH TEMPERATURE THERMOPLASTIC, BLACK, UL94V–0.
TERMINALS – 0.36[.014] THICK PHOS BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK BRIGHT TIN LEAD IN SOLDER AREA. 1.27µm [0.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm [0.000050] MINIMUM THICK NICKEL.
SHIELD – 0.196[.0077] THICK COPPER ZINC ALLOY PREPLATED WITH 1.27µm[0.000050] MINIMUM SATIN NICKEL WITH 2.03µm[0.000080] MINIMUM TIN POST DIPPED ON PCB GROUND TABS.
LIGHT EMITTING DIODE (LED) – DIFFUSED EPOXY LENS, 0.51 x 0.51[.020 x .020] CARBON STEEL (WIREFRAME LEADS) PREPLATED WITH 8.89µm[0.000350] THICK TIN/COPPER OVER 2.03µm[0.000080] THICK SILVER OVER 1.02µm[0.000040] THICK COPPER OVER 3.56µm[0.000140] THICK NICKEL OVER 1.02µm [0.000040] THICK COPPER UNDERPLATE
- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- SUGGESTED PANEL OPENING DIMENSIONS.
- SUGGESTED CLEARANCE BETWEEN TOP OF CONNECTOR AND TOP PANEL OPENING.
- 0.051[.002] WHITE POLYESTER INSULATOR APPLIED TO BACK OF HOUSING.
- SEE TABLE FOR COLOR OF LEDS AND NUMBER REQUIRED.
- THIS MODULAR JACK WITH INTEGRATED LED IS NOT IR REFLOW SOLDERING PROCESS COMPATIBLE.

GREEN	GREEN	1116173–5
GREEN	YELLOW	1116173–4
YELLOW	GREEN	1116173–1
POSITION 2	POSITION 1	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN D. STRAUSSER	25MAR98	Tyco Electronics Corporation Harriaburg, PA 17105–3608	
DIMENSIONS: mm [INCHES]		CHK E. LAURER	27MAR98	NAME	
		APVD E. LAURER	27MAR98	PRODUCT SPEC	
		108–1163–4		APPLICATION SPEC	
		114–2154		RESTRICTED TO	
MATERIAL SEE NOTE 1	FINISH SEE NOTE 1	WEIGHT —	SIZE A1	CAGE CODE 00779	DRAWING NO 1116173
CUSTOMER DRAWING		SCALE 4:1	SHEET 1	OF 1	REV E